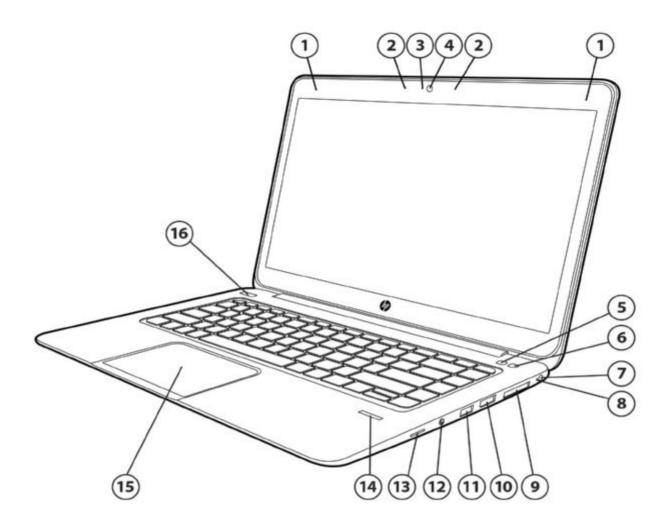
Overview

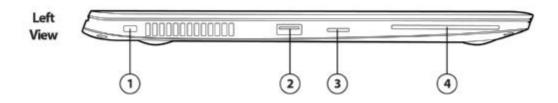


- 1. WLAN antennas (2)
- 2. Dual-microphone array
- 3. Webcam light (only with optional webcam)
- 4. Optional 720p HD webcam
- 5. Wireless on/off button with LED indicator
- 6. Speaker mute button with LED indicator
- 7. Power connector
- 8. Power LED indicator

- 9. Docking connector
- 10. DisplayPort 1.2
- 11. USB 3.0 port
- 12. Headphone/microphone combo
- 13. WWAN sim slot with plug (Plug is removable only for units with optional WWAN
- 14. Fingerprint reader
- 15 ForcePad™
- 16. Power button



Overview



- 1. Security lock
- 2. USB 3.0 charging port

- 3. Micro-SD card slot
- Smart Card Reader

### At A Glance

- Windows 8.1 versions, Windows 7 versions, SuSE Linux or FreeDOS 2.0
- Magnesium display enclosure, magnesium-reinforced chassis, wear-resistant platinum-colored HP DuraFinish, HP DisplaySafe frame, HP DuraKeys, precision metal-alloy hinges, aluminum keyboard deck
- Ensured durability through MIL-SPEC 810G testing, plus an additional 115,000 hours of reliability testing through HP's Total Test Process
- Choice of 4th Generation Intel® Core™ i7 and i5 with Turbo Boost Technology
- Integrated Intel HD Graphics 4400 or 5000 (i7-4650U)
- 14.0-inch diagonal HD+ or FHD\* widescreen LED-backlit display
- Choice of 256 GB SED Solid State Drive (available March 2014), 256 GB Solid State Drive, 180 GB SED Solid State Drive (available March 2014), 180 GB Solid State Drive, or 128 GB Solid State Drive
- Built-in docking for a desktop-like experience
- DisplayPort 1.2 for high resolution support
- HD Audio with DTS Studio Sound™ optimized for high fidelity audio during video conferencing and web-based training
- 6-cell (42 WHr) HP Long Life battery for battery life up to 9 hours and 45 minutes
- ForcePad™ that enables multiple gestures and eliminates the need for repetitive motion and makes navigation easier
- Integrated Smart Card Reader and fingerprint reader for strong security authentication
- HP Premier Image with Microsoft Security Essentials and without trialware
- HP BIOSphere with HP Sure Start
- Flexible wireless connectivity options:
  - O Optional integrated wireless mobile broadband 3G and 4G/LTE support
  - O Integrated Intel® 802.11 a/b/g/n (2x2), Intel® 802.11 a/b/g/n (2x2) with Bluetooth® v4.0 Combo, or Intel®802.11 a/b/g/n (2x2) AC with Bluetooth® v4.0 Combo
- Low halogen, ENERGY STAR qualified (with Microsoft OS) and EPEAT Gold registered in the U.S. (with Microsoft OS). EPEAT status varies by country- please see epeat.net.

**NOTE:** See important legal disclosures for all listed specs in their respective features sections.





**Features** 

## **PRODUCT NAME**

HP EliteBook Folio 1040 G1 Notebook PC

### OPERATING SYSTEM

Preinstalled Windows 8.1 Pro 64\*

Windows 8.1 64\*

Windows 7 Professional 32 (available through downgrade rights from Windows 8.1 Pro

64)\*\*

Windows 7 Professional 64 (available through downgrade rights from Windows 8.1 Pro

64)\*\*

Windows 7 Professional 32\*\*\*
Windows 7 Professional 64\*\*\*
Windows 7 Home Premium 32\*\*\*
Windows 7 Home Premium 64\*\*\*

FreeDOS 2.0

Windows 8 Enterprise\*
Windows 7 Enterprise 32\*\*\*
Windows 7 Enterprise 64\*\*\*
Windows 7 Liltimate 32\*\*\*

SUSE Linux Enterprise

Windows 7 Ultimate 32\*\*\*
Windows 7 Ultimate 64\*\*\*

Certified SUSE Linux Enterprise Desktop

### **PROCESSOR**

Supported

4th Generation Intel® Core™ i7-4600U with Intel HD Graphics 4400 (2.1 GHz, 4 MB cache, 2 cores)\* Up to 3.3 GHz with Intel Turbo Boost Technology

4th Generation Intel® Core™ i7-4650U with Intel HD Graphics 5000 (1.7 GHz, 4 MB cache, 2 cores)\* Up to 3.3 GHz with Intel Turbo Boost Technology

4th Generation Intel® Core™ i5-4300U with Intel HD Graphics 4400 (1.9 GHz, 3 MB cache, 2 cores)\* Up to 2.9 GHz with Intel Turbo Boost Technology

4th Generation Intel® Core™ i5-4200U with Intel HD Graphics 4400 (1.6 GHz, 3 MB cache, 2 cores)\*† Up to 2.6 GHz with Intel Turbo Boost Technology

† Not available with vPro

\* Multi-Core is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. 64-bit computing on Intel® architecture requires a computer system with a processor, chipset, BIOS, operating system, device drivers, and applications enabled for Intel® 64 architecture. Processors will not operate (including 32-bit operation) without an Intel® 64 architecture-enabled BIOS. Performance will vary depending on your hardware and software configurations. Intel's numbering is not a measurement of higher performance.

**NOTE**: Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.



<sup>\*</sup> Not all features are available in all editions of Windows 8.1. Systems may require upgraded and/or separately purchased hardware, drivers and/or software to take full advantage of Windows 8.1 functionality. See <a href="http://www.microsoft.com">http://www.microsoft.com</a> for details.

<sup>\*\*</sup> This system is preinstalled with Windows® 7 Pro software and also comes with a license and media for Windows 8 Pro software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

<sup>\*\*\*</sup> Not all features are available in all editions of Windows 7. This system may require upgraded and/or separately purchased hardware to take full advantage of Windows 7 functionality. See <a href="http://www.microsoft.com/windows/windows-7/">http://www.microsoft.com/windows/windows-7/</a> for details.

**Features** 

### CHIPSET

Integrated with processor

### INTEL CORE IS WITH VPRO/CORE I7 WITH VPRO TECHNOLOGY CAPABLE

Intel Core i5 with vPro and Core i7 with vPro technology is a selectable feature that is available on units configured with select processors, an Intel Centrino® Advanced-N or Ultimate-N WLAN module and a preinstalled Windows operating system. It provides advances in remote manageability, security, energy efficient performance, and wireless connectivity. Intel Active Management Technology 9.0 (iAMT) offers built-in manageability and proactive security for networked notebook PCs, even when they are powered off\* or when the operating system is inoperable. It can help identify threats before they reach the network, isolate infected systems, and update PCs regardless of their power state.

\*Requires a Windows operating system, network hardware and software, connection with a power source, and a direct (non-VPN) corporate network connection which is either cable or wireless LAN.

**NOTE:** Some functionality of Intel® Core i5 with vPro/Core i7 with vPro technology, such as Intel® Active Management technology and Intel® Virtualization technology, requires additional third- party software in order to run. Availability of future "virtual appliances" applications for Intel® Core i5 with vPro/Core i7 with vPro technology is dependent on third- party software providers. Compatibility with future "virtual appliances" is yet to be determined.

## **GRAPHICS**

Integrated: Intel® HD Graphics 4400 Intel® HD Graphics 5000

#### **DISPLAY**

#### Internal

14.0" diagonal eDP, slim, LED-backlit HD+\* 16:9 widescreen anti-glare SVA (1600 x 900) 14.0" diagonal eDP, slim, LED-backlit FHD\* widescreen anti-glare UWVA (1920 x 1080), 300 nits

#### **External**

Up to 32-bit per pixel color depth (250 nits)

#### **DisplayPort**

Supports resolutions up to 2560 x 1600, 30-bit color depth at 60 Hz, and full HD\* (1920 x 1080) monitors, 24-bit color depth at 120 Hz\* HD content required to view HD images.

NOTE: Resolutions are dependent upon monitor capability, and resolution and color depth settings.



#### **Features**

### STORAGE AND DRIVES

#### **Primary Storage Bay**

#### **Solid State Drive**

SATA 6 Gb/s 128 GB\* Solid State SATA 6 Gb/s 180 GB\* Solid State

SATA 6 Gb/s 180 GB\* SED Solid State (available March 2014)

SATA 6 Gb/s 256 GB\* Solid State

SATA 6 Gb/s 256 GB\* SED Solid State (available March 2014)

\* For hard drives and solid state drives, GB = 1 billion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 7) and up to 36 GB (for Windows 8.1) of system disk is reserved for the system recovery software.

NOTE: The EliteBook Folio is available in standard thin and light configurations for customers who value the ultrathin design but prefer options such as a standalone HDD or require a self-encrypting hard drive. These configurations will not meet Intel's definition of an Ultrabook.

### **MEMORY**

#### Standard

DDR3L SDRAM (1600 MHz, 1.3v)

One SODIMM slot

Standard memory 4096 MB soldered down

#### **Maximum**

Upgradeable to 8192 MB with optional 4096 MB SODIMM in slot and 4096 MB soldered down

**NOTE:** Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed. With Windows Starter 32-bit operating systems, the amount of usable memory is dependent upon your configuration, so that above 3 GB all memory may not be available due to system resource requirements.

#### NETWORKING/COMMUNICATIONS

### Wireless

Support for a broad range of secure, integrated wireless LAN and wireless WAN options featuring support for the latest industry standards. Broadband Wireless (WWAN) requires a Windows operating system and is available in select countries. Wireless LAN and integrated Bluetooth are also available (both are factory configurable only) and can be combined with any of the supported wireless WAN options.

## **Broadband Wireless (WWAN)**

HP It4111 LTE/EV-DO/SHPA+ Mobile Broadband Module \*,\*\*
HP It4112 LTE/HSPA+ Mobile Broadband Module (EMEA only) \*,\*\*
HP hs3110 HSPA+ Mobile Broadband Module \*

#### Integrated wireless LAN options

Intel® 802.11 a/b/g/n (2x2)\*\*\*

Intel® 802.11 a/b/g/n (2x2) with Bluetooth® v4.0 Combo\*\*\*

Intel®802.11 a/b/g/n (2x2) AC with Bluetooth® v4.0 Combo\*\*\*, \*\*\*\*

\* WWAN modules are only available if preconfigured. WWAN connection requires wireless data service contract, network support, and is not available in all areas. Contact service provider to determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, and other factors.

\*\* 4G LTE not available on all products, in all regions and requires Windows.

\*\*\*Wireless access point and Internet service is required and is not included. Availability of public wireless access points limited.

\*\*\*\* The specifications for the 802.11ac WLAN are draft specifications and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ac



#### **Features**

WLAN devices.

#### Communications

Intel® 1218LM Gigabit Network connection\*

\* The term "10/100/1000" or "Gigabit" Ethernet indicates compatibility with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/s. For high-speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

## **AUDIO/MULTIMEDIA**

### Audio

HD Audio with DTS Studio Sound Integrated stereo speakers Integrated dual-microphone array located in display Button for speaker mute; function keys for volume up and down Headphone/Microphone combo port

#### Webcam

Optional\* 720p HD\*\* webcam

- HD format (widescreen)
- Supports videoconferencing and still image capture
- High quality fixed focus lens
- Video capture at various resolutions up to 1280x720 resolution (720p) and up to 30fps
- M-JPEG compression supports higher frame rates for video capture and videoconferencing
- Improved low light sensitivity
- Improved dynamic range

## **KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS**

#### Keyboard

The HP spill-resistant, backlit keyboard is designed using a thin layer of Mylar film under the keyboard and a drain system that funnels fluid through a hole in the bottom of the notebook. This minimizes the risk of damage to sensitive components underneath. The 101/102-key compatible keyboard features a full-pitch key layout with desktop keyboard features, such as the isolated inverted-T cursor control keys, editing keys, both left and right control and alt keys, 12 function keys, and 19.05 x 19.05 mm key pitch (center-to-center spacing). U.S. and International key layouts are available. Other features include hot keys for instant access to power conservation and brightness.

#### **Pointing Devices**

A pressure-sensing ForcePad™ that eliminates the need for repetitive motion and makes navigation easier

#### **Buttons and Function Keys**

Discrete buttons provide easy access to the following features: wireless on/off, and speaker mute. Function keys provide control of the following features: sleep mode, external display switching, volume down, volume up, microphone mute, backlit keyboard, and display brightness.



<sup>\*</sup> Sold separately as an optional feature.

<sup>\*\*</sup> HD content required to view HD images.

#### **Features**

### SOFTWARE AND SECURITY

#### **Preinstalled Software with Windows Operating System**

HP BIOSphere with HP Sure Start\*

Buy Office

HP Connection Manager (Win 7)

HP Wireless HotSpot\*\*

HP Mobile Connect (EMEA only)

HP PageLift

HP Recovery Manager

**HP Support Assistant** 

HP ePrint\*\*\*

Lync Optimized\*\*\*\*

- \* HP Sure Start is only available on the EliteBook 800 series, Workstation ZBook series and HP EliteBook Folio 1040.
- \*\* The wireless hotspot application requires an active internet connection and separately purchased data plan. While HP wireless hotspot is active, on-device applications will continue to work and will use the same data plan as the wireless hotspot. Wireless hotspot data usage may incur additional charges. Check with your service provider for plan details. Requires Windows 8.
- \*\*\* Requires an Internet connection to HP web-enabled printer and HP ePrint account registration (for a list of eligible printers, supported documents and image types and other HP ePrint details, see www.hp.com/go/eprintcenter). Requires optional broadband module. Broadband use requires separately purchased service contract. Check with service provider for coverage and availability in your area. Separately purchased data plans or usage fees may apply. Print times and connection speeds may vary.

  \*\*\*\* Lync software is sold separately. Requires internet access.

**NOTE:** HP Recovery Manager enables fast recovery of the factory preinstalled image if the system becomes corrupted or if important system files are accidentally deleted. Up to 30 GB (for Windows 7) and up to 36 GB (for Windows 8.1) of system disk is reserved for the system recovery software.

### Security

#### Standard

HP Trust Circles Standard (Available in Fall 2013)\*
HP Client Security
TPM 1.2 Embedded Security Chip
Integrated Smart Card Reader
HP Fingerprint Sensor (100%)
Full Volume Encryption
Security Lock Slot
Microsoft Security Essentials

\* HP Trust Circles Standard, when included, allows up to 5 Trust Circles with up to 5 contacts in each Trust Circle. Optional Trust Circles Professional required for unrestricted number of Trust Circles and members contacts. Trust Circles Reader is available to allow a contact to participate in an invited Trust Circle. Requires Windows.

For more information on HP security solutions refer to: http://www.hp.com/go/security



#### **Features**

### **POWER**

#### **Power Supply**

45W Smart AC Adapter

45W Slim Smart AC Adapter non-slim 2 prong (Japan only)

65W Smart EM AC Adapter

65W Slim Smart AC Adapter

Power cord included is either 3.2 feet or 6 feet (1.0 or 1.8 meter).

Total length including external AC adapter is TBD feet (TBD meter).

#### **Primary Battery**

HP 6-Cell (42Whr) polymer long life battery

#### **Battery Life\***

Up to 9 hours and 45 minutes

#### **System Standby Time**

Up to TBD weeks

\* Windows 7 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See <a href="https://www.bapco.com">www.bapco.com</a> for additional details.

#### **Power Conservation**

Hibernation Standby ACPI compliance

### **ENVIRONMENTAL**

US ENERGY STAR® qualified (with Microsoft OS)
Low Halogen (does not cover adapters and power cords)

IT ECO Declaration

EPEAT® Gold in the U.S. See www.epeat.net for registration status by country.

**NOTE:** This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks.

#### **WEIGHTS & DIMENSIONS**

#### Weight

Starting at 3.3 lbs (1.49 kg) (Weight will vary by configuration.)

**Dimensions** (w x d x h) 13.31 x 9.19 x 0.63 in 33.8 x 23.35 x 1.59 cm

**NOTE:** Weight varies by configuration and components. Weight includes 6-cell battery, mSATA solid state drive, and 4 GB memory. Weight varies by configuration and components.



#### **Features**

## PORTS/SLOTS

#### **Ports**

DisplayPort - One (v1.2)
Headphone/Microphone combo port - One
Power Connector - One
Docking Connector - One
USB 3.0 - One
USB 3.0 charging port - One

## **Digital Media Slots**

Micro-SD card reader supports SD, SDHC, SDXC

#### SERVICE AND SUPPORT

Limited 3-year, 1-year and 90-day warranty options available, depending on country, 3-year limited warranty on HP Long Life Battery (only available with 3-year platform warranty). Optional\* HP Care Pack Services\*\* are extended service contracts which go beyond your standard warranties. For more details visit; http://www.hp.com/go/cpc.

\*Sold separately or as an optional feature.

\*\* Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. Consult the HP Customer Support Center for details. http://h20000.www2.hp.com/bizsupport/TechSupport/ProductRoot.jsp

**NOTE:** Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit: www.hp.com/go/cpc



## Technical Specifications

### SYSTEM UNIT

**Stand-Alone Power** 

**Nominal Operating** Voltage

18.5 V

Requirements (AC Power)

**Average Operating** Windows 7 (32-bit) Windows 7 (64-bit)

**Power** 

TBD W

TBD W

Max Operating Power < 65 W

Operating

32° to 95° F (0° to 35° C) (not writing optical)

Non-operating

-4° to 140° F (-20° to 60° C) 10% to 90%, non-condensing

**Relative Humidity** 

Operating

Shock

**Temperature** 

Non-operating Operating

5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature

Non-operating

40 G, 2 ms, half-sine 200 G, 2 ms, half-sine

**Random Vibration** 

Operating

0.75 grms

Non-operating 1.50 grms

Altitude (unpressurized) Operating

-50 to 10,000 ft (-15.24 to 3,048 m) Non-operating -50 to 40,000 ft (-15.24 to 12,192 m)

**Planned Industry Standard** Certifications

UL **CSA** 

**EPEAT** 

Yes **FCC Compliance** Yes

**ENERGY STAR®** 

Select models (Microsoft OS)\* Registered Gold in United States\*\*

**ICES** Australia /

Yes

**NZ A-Tick Compliance** 

CCC Japan VCCI Yes Yes

Yes

Compliance

KC

CIT

**GOST** 

**BSMI** 

Yes Yes

**CE Marking** 

Yes

Compliance

**BNCI or BELUS** 

Yes Yes Yes

Saudi Arabian

Yes

Compliance (ICCP) **SABS** 

Yes

**UKRSERTCOMPUTER** Yes

For accessibility information on HP products, please visit: http://www.hp.com/accessibility.



<sup>\*</sup> Configurations of the HP EliteBook Folio 1040 G1that are ENERGY STAR qualified are identified as HP EliteBook Folio 1040 G1 ENERGY STAR on HP websites and on www.energystar.gov.

<sup>\*\*</sup>EPEAT® Gold in the U.S. See www.epeat.net for registration status by country.

# **Technical Specifications**

## **DISPLAY**

14" diagonal LEDbacklit HD+ anti-glare SVA flat (1600 x 900) **Outline Dimensions** 

(W x H x D)
Active Area

12.6 x 8.09 x 0.12 in (32.09 x 20.56 x 0.3 cm)

12.19 x 6.86 in (30.96 x 17.415 cm)

**Weight** 0.72 lb (325 g) (max) **Diagonal Size** 14.0 in (35.6cm)

Surface TreatmentAnti-glareContrast Ratio300:1 (min)Refresh Rate60 Hz

**Brightness** 250 nit (typical)

Pixel Resolution Format 1600 x 900 (HD+)

Configuration RGB Stripe

Interface eDP 1.2 (1 lane)

LCD Mode TN 131 ppi

Viewing Angle SVA 40/40/15/30 (Left/Right/Down/Up)

14" diagonal LEDbacklit FHD anti-glare UWVA slim (1920 x 1080) **Outline Dimensions** 

12.6 x 8.09 x 0.12 in (32.09 x 20.56 x 0.3 cm)

 $(W \times H \times D)$ 

**Active Area** 12.18 x 6.85 in (30.93 x 17.4 cm)

**Weight** 0.75 lb (340 g) (max) **Diagonal Size** 14.0 in (35.6cm)

Touch enabled Yes
Surface Treatment Anti-glare
Contrast Ratio 600:1 (min)
Refresh Rate 60 Hz

Brightness 300 nit (typical)

Pixel Resolution Format 1920 x 1080 (FHD)

Configuration RGB Stripe

Interface eDP 1.3+PSR (2 lane)

LCD Mode IPS/FFS/VA PPI 157 ppi

Viewing Angle UWVA 85/85/85 (Left/Right/Down/Up)

### STORAGE AND DRIVES

#### Internal Storage

The EliteBook Folio is available in standard thin and light configurations for customers who value the ultra-thin design but prefer options such as a standalone HDD or require a self-encrypting hard drive. These configurations will not meet Intel's definition of an Ultrabook.



**Technical Specifications** 

128 GB\* M.2 Solid State Drive Weight

**Drive** 

Drive Weight 10 grams
Capacity 128 GB

 Height
 0.091 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Interface
 SATA 3 (6 Gb/s)

Performance Maximum Sequential Maximum Sequential Write

Read

Up to 515 MB/s Up to 465 MB/s

**Logical Blocks** 250,069,680

**Operating Temperature**32° to 158°F (0° to 70°C) [case temp]

10 grams

Features ATA Security; ATA-8; SATA 3.0; DIPM; TRIM

180 GB\* M.2 Solid State Drive Weight

Drive

Capacity 180 GB

 Height
 0.091 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Interface
 SATA Gen 3 (6 Gb/s)

Performance Maximum Sequential Maximum Sequential Write

Read

Up to 540 MB/s Up to 490 MB/s

**Logical Blocks** 351,651,888

Operating Temperature32° to 158°F (0° to 70°C) [case temp]

Features ATA Security; ATA-8, SATA 3.0; DIPM; TRIM

256 GB\* M.2 Solid State Drive Weight

**Drive** 

**Drive Weight** 10 grams **Capacity** 256 GB

 Height
 0.091 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Interface
 SATA Gen 3 (6 Gb/s)

Performance Maximum Sequential Maximum Sequential Write

Read

Up to 515 MB/s Up to 465 MB/s

**Logical Blocks** 500,118,192

**Operating Temperature**32° to 158°F (0° to 70°C) [case temp]

Features ATA Security; ATA-8, SATA 3.0; DIPM; TRIM



180 GB\* M.2 SED Solid Drive Weight

**State Drive** 

Drive Weight 10 Grams
Capacity 180 GB

 Height
 0.091 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Interface
 SATA 3 (6 Gb/s)

Performance Maximum Sequential Maximum Sequential Write

Read

Up to 540 MB/s Up to 490 MB/s

**Logical Blocks** 351,651,888

**Operating Temperature**32° to 158°F (0° to 70°C) [case temp]

Features ATA Security; ATA-8, SATA 3.0; DIPM; TRIM; TCG Opal 1.0

SATA 6 Gb/s 256 GB\*, 2.5-inch SATA SED Solid State Drive (available March 2014) Drive Weight TBD Grams
Capacity 256 GB

HeightTBD in (TBD mm)WidthTBD in (TBD mm)InterfaceSATA 3 (6 Gb/s)

Performance Maximum Sequential Maximum Sequential Write

Read

Up to TBD MB/s Up to TBD MB/s

Logical BlocksTBDOperating TemperatureTBDFeaturesTBD

## **SECURITY**

HP Fingerprint Reader Mobile Voltage 3.0V-3.6V

Operation

**Operating Temperature**14° - 167°F (-10° - 75°C)

Current Consumption 36 mA peak

**Image** 

Low Latency Wait for 950 uA

**Finger** 

Capture Rate 3000. lines/sec

ESD Resistance IEC 61000-4-2 4B (±15KV)

**Detection Matrix** 200\*1 (plus another secondary line)

508 dpi

12\*3 mm sensor area



**Smart Card Reader** 

Smart card standard PC/SC 2.0 for Windows smart card standard

**Dimensions** (L x W x H) 0.41x 0.08 x 0.32 in (10.5 x 2 x 8.2 mm)

Smart Card support ISO 7816 Class A and AB smart cards

**Smart Card Interface** Smart Card Interface with T = 0 and T = 1 support

Support I2C memory card, SLE4418, SLE4428, SLE4432, SLE4442,

SLE4436,

SLE5536, SLE6636, AT88SC1608, AT45D041 card and AT45DB041

card via

external EEPROM

Operating systems No driver is required for this device. Native support is provided by the

operating system.

**Power** Normal Mode With card present, before being suspended:

40.9 mA

Without card present, before being

suspended: 33.16 mA

After being suspended with smart card

present: 380 µA

After being suspended without smart card

present: 380 µA

**Power Saving** 

Mode

With card present, before being suspended:

40.6 mA

Without card present: 380 µA

After being suspended with smart card

present: 380 µA

**Features** 

Support single slot

Support T0, T1 protocol

 Support I2C memory card, SLE4418, SLE4428, SLE4432, SLE4442, SLE4436,

 SLE5536, SLE6636, AT88SC1608, AT45D041 card and AT45DB041 card via external EEPROM

Support ISO7816 Class A, B and C (5V/3V/1.8V) card

• Implemented as an USB full speed device with bulk transfer endpoint, Mass

Storage endpoint

• Built-in PLL for USB and Smart Card clocks requirement

 Support EEPROM for USB descriptors customization (PID/VID/ iManufacturer/iProduct/Serial Number), Direct Web Page Link, and accessing memory card module.

• EEPROM programmable via USB interface

Support software update for memory card module

 Support Direct Web Page Link via configuration in external EEPROM

Support short APDU and extended APDU

• Compatible with Microsoft USB-CCID driver

Support remote wake up through inserting card/removing card

Support USB selective suspend

 Support Power Saving Mode (Using one pin to select between Normal/PWR Saving Mode)

• Support card power over current protection mechanism

• Built in resonator.

Support USB LPM (Link Power Management) features.
 Embedded clock source.



**Technical Specifications** 

## **NETWORKING/COMMUNICATIONS**

Intel I218LM Gigabit Network Connection

System Interface Integrated on PCA

Controller Intel I218LM GbE platform LAN connect networking controller

**Memory** 24 KB FIFO packet buffer memory

Data rates supported 10/100/1000 Mbps

IEEE Compliance 802.1P

802.1Q 802.2 802.3 802.3ab 802.3az 802.3u

Bus architecture PCI Express and SMBus

**Data transfer mode** PCIe-based interface for active state operation (S0 state) and SMBus

for host and management traffic (Sx low power state)

**Power requirement** Requires 3.3V and 0.9V or just 3.3V with integrated regulators

Power consumption 0.733 Watts

**Boot ROM support** Yes

Network transfer mode Full-duplex

Half-duplex (not supported for the 1000BASE-T transceiver)

Network transfer rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

**Environmental** Operating Temperature: 0° to 85° C

Operating Humidity: 60% RH

Management WOL, auto MDI crossover, PXE, Muti-port teaming, RSS, Advanced

cable diagnostic.

Alerting ASF 2.0 support; iAMT 9.0 support



**Mobile Broadband** Module\*

HP hs3110/3114 HSPA+ Technology/Operating Modes: WCDMA/HSDPA/HSUPA/HSPA+/AWS/GSM/EDGE/GPRS

Penta-band WCDMA/HSDPA/HSUPA/HSPA+/AWS:

850/900/1900/2100/AWS MHz

GSM/GPRS/EDGE: 850/900/1800/1900 MHz

**Wireless Protocol** 

**Standards** 

GSM/GPRS/EDGE: Class B, Multi-slot class 33, coding schemes CS1

CS4 and MSC1 - MSC9.

UMTS/WCDMA: Release 99 and Release 7

Advanced Receiver Type 3i

**GPS** GPS Standalone, A-GPS: L1 (Internet- and Network assisted)

Wireless parametric

standards

Complies with 3GPP specifications

Maximum data rates GPRS/EDGE: Multi-slot Class 33, Class B

> WCDMA PS: UL (384 kbps) / DL (384 kbps) UL/DL HSPA: UL (5.76 Mbps)/ DL (7.2 Mbps) UL/DL HSPA+: UL (5.76 Mbps)/ DL (21Mbps)

Maximum output powerWCDMA/HSPA/HSPA+ 2100/1900/900/850/AWS MHz:

+24dBm (Power Class 3)

GPRS 1900/1800 MHz: +30dBm (Power Class 1) GPRS 900/850 MHz: +33dBm (Power Class 4) EDGE 1900/1800 MHz: +26dBm (Power Class E2) EDGE 900/850 MHz: +27dBm (Power Class E2)

Maximum power

consumption

2500mA (peak); 600mA (average)

Power consumption,

sleep mode

3.6 mA

**Power management** USB selective suspend, Connected Standby

Integrated notebook wireless button

Dual high efficiency 5 band antennae with spatial diversity, mounted in Antenna type

the display enclosure

**Form Factor** M.2 Socket 2, USB 2.0 interface high speed

Weight

**Dimensions** (Length x

Width x Thickness)

2.01 x 1.18 x 0.18 in (42 x 30 x 2.3 mm)

SIM card supply

voltage

1.8 V/3.0 V UICC (SIM/UICC/USIM)

Voltage, Operating 3.135V~4.4V (3.3 V recommended)

14° to 131° F (-10° to 55° C) (Normal operation) Temperature, Operating -4° to 158° F (-20° to 70° C) (Extended operation)

Temperature, storage -40° to 185° F (-40° to 85° C)

LED Off - Radio Off; Solid LED On - Radio On **Humidity** 

Configuration utilities HP Connection Manager

**LED Activity** LED Off - Radio Off; Solid LED On - Radio On

\* Mobile Broadband is an optional feature sold separately or as an add on feature. Connection requires wireless data service contract, network support, and is not available in all areas. Contact service provider to determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, and other factors.

**HP It4111 LTE/EV-**DO/HSPA+ 4G WWAN\* Bands

Technology/Operating LTE FDD all bands with diversity: 1900 MHz (Band II)<sup>1</sup>, 1700/2100MHz (Band IV (AWS), 850 MHz (Band V), 700MHz (Band XIII), 700MHZ

(Band XVII), 1900MHz G Block (Band XXV)

WCDMA/HSDPA/HSUPA/HSPA+: all bands with diversity: 2100 MHz (Band I), 1900 MHz (Band II), AWS 1700/2100MHz (Band IV), 850 MHz



# Technical Specifications

(Band V), 800 MHz (Band VIII)

GSM/GPRS/EDGE: 1900 MHz, 1800 MHz, 850 MHz, 900 MHz

CDMA: Cellular 800MHz (BC0), PCS 1900MHz (BC1)

**Wireless Protocol** 

3GPP Release 8 LTE Specification

**Standards** WCDMA R99, 3GPP Release 5, 6 and 7 UMTS Specification

EVDO Release 0 and Release A

Wireless Parametric

**Standards** 

Complies with 3GPP specifications Release 8 for LTE

**Maximum Data Rates** LTE (Category 3): 100 Mbps (Download), 50Mbps (Upload)

> DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21.6 Mbps (Download), 5.76 Mbps (Upload) EDGE: 236.8 kbps (Download), 236.8 kbps (Upload) GPRS: 85.6 kbps(Download), 85.6 kbps (Upload)

**GPS** Standalone GPS, A-GPS, GPS XTRA

**GPS Bands** 1575.42 MHz (± 1.023 MHz), GLONASS 1596-1607MHz

**Maximum Output** 

**Power** 

LTE: +23 dBm (+/- 1 dBm) WCDMA: +23 dBm (+/- 1 dBm)

GSM850/900, GMSK: +32dBm (+/- 1dBm) GSM850/900, 8PSK: +27dBm (+/- 1dBm)

DCS1800 / PCS 1900, GMSK: +29dBm (+/- 1dBm) DCS1800 / PCS 1900, 8PSK: +26dBm (+/- 1dBm)

CDMA: +24dBm (+/- 1dBm)

**Maximum Power** 

Consumption

LTE: 1,200 mA (peak); <900 mA (average) WCDMA: 1,100 mA (peak); <800 mA (average) EGPRS: 2,500 mA (peak); <700 mA (average)

**Power Consumption,** 

Sleep Mode

2 mA

**Power Management** 

USB selective suspend, Integrated notebook wireless button **Antenna Type** Dual high efficiency multi-band antennae with spatial diversity

**Form Factor** M.2, 3042-S3 Key B

Weight

**Dimensions** (Length x

Width x Thickness)

Voltage, Operating

3.135 V to 4.4 V (3.3 V +1.1V/-0.165V)

42 mm × 30 mm × 2.3 mm

Temperature, operating-13° to 140° F (-25° to 60° C)

(from TIA/EIA/IS-98-D)

Temperature, nonoperating, 96 hours (from MIL-STD 202

-40° to 185° F (-40° to 85° C)

**Humidity, Non-**

95% relative humidity for 48 hours @ 185° F (85° C) (non-condensing)

operating

Method 108)

**LED Activity** LED Off - Radio Off; Solid LED On - Radio On

1 1900 MHz (Band II) and 850 MHz (Band V) not supported at launch but support planned in a future firmware update.

\* 4G LTE not available on all products, in all regions and requires Windows. WWAN use requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors.



HP It4112 LTE/HSPA+ Gobi 4G Module\*

**Bands** 

Technology/Operating LTE FDD all bands with diversity: 2100 MHz (Band I), 1900 MHz (Band II), 1800 MHz (Band III), 850 MHz (Band V), 2600 MHz (Band VII), 900

MHz (Band VIII), 800 MHz (Band XX, DD800)

WCDMA/HSDPA/HSUPA/HSPA+ all bands with diversity: 2100 MHz (Band I), 1900 MHz (Band II), 850 MHz (Band V), 900 MHz (Band VIII) GSM/GPRS/EDGE: 1900 MHz (Band II), 1800 MHz (Band III), 850 MHz

(Band V), 900 MHz (Band VIII)

**Wireless Protocol** 

3GPP Release 8 LTE Specification

**Standards** 

WCDMA R99, 3GPP Release 5, 6 and 7 UMTS Specification

**Wireless Parametric** 

**Standards** 

Complies with 3GPP specifications Release 8 for LTE

**Maximum Data Rates** LTE (Category 3): 100 Mbps (Download), 50Mbps (Upload)

> DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21.6 Mbps (Download), 5.76 Mbps (Upload) EDGE: 236.8 kbps (Download), 236.8 kbps (Upload) GPRS: 85.6 kbps(Download), 85.6 kbps (Upload)

**GPS** 

**GPS Bands** 1575.42 MHz (± 1.023 MHz), GLONASS 1596-1607MHz

**Maximum Output** 

**Power** 

LTE: +23 dBm (+/- 2 dBm) WCDMA: +23.5 dBm (+/- 1 dBm)

GPRS Band II, III: +29.5 dBm (+/- 1 dBm) GPRS Band V, VIII: +32.5 dBm (+/- 1 dBm) EGPRS Band II, III: +26.5 dBM (+/-1.5 dBm) EGPRS Band V, VIII: +27.5 dBM (+/-1.5 dBm)

**Maximum Power** Consumption

LTE: 1,200 mA (peak); <900 mA (average) WCDMA: 1,100 mA (peak); <800 mA (average) EGPRS: 2,800 mA (peak); <700 mA (average)

**Power Consumption,** 

Sleep Mode

3 mA

**Power Management** USB selective suspend, Integrated notebook wireless button Dual high efficiency multi-band antennae with spatial diversity **Antenna Type** 

Form Factor M.2, USB 2.0 interface

Weight

**Dimensions** (Length x

Width x Thickness)

42 mm × 30 mm × 2.3 mm

Voltage, Operating 3.135 V to 4.4 V (3.3 V +1.1V/-0.165V)

Temperature, operating 14° to 131° F (-10° to 55° C)

(from TIA/EIA/IS-98-D)

Temperature, nonoperating, 96 hours

-40° to 185° F (-40° to 85° C)

(from MIL-STD 202 Method 108)

**Humidity, Non-**

95% relative humidity for 48 hours @ 185° F (85° C) (non-condensing)

operating

LED Off - Radio Off; Solid LED On - Radio On **LED Activity** 

\* 4G LTE not available on all products, in all regions and requires Windows. WWAN use requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors.

Intel Dual Band Wireless-N 7260NB Wireless LAN IEEE 802.11a **Standards** IEEE 802.11b



**Technical Specifications** 

802.11 a/b/g/n (2x2) WiFi Adapter\* IEEE 802.11g IEEE 802.11n

Interoperability Wi-Fi certified

Cisco Compatible Extensions Program compliant with Microsoft

Windows 7, Windows Vista and XP (details at: http://www.hp.com/go/notebooks/WLAN)

**Frequency Band** 802.11b/g/n 2.402 - 2.482 GHz

802.11a/n 4.9 - 4.95 GHz (Japan)

5.15 - 5.25 GHz 5.25 - 5.35 GHz 5.47 - 5.725 GHz 5.825 - 5.850 GHz

Antenna Structure 2 transmit; 2 receive (2x2)

**Data Rates** 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

802.11b: 1, 2, 5.5, 11 Mbps

802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

802.11n: card will support rates for NSS=1 and NSS=2 for RX and TX for 20 and 40 MHz channels. Short and long guard interval shall be

supported.

Modulation Direct Sequence Spread Spectrum

CCK, BPSK, QPSK, 16-QAM, 64-QAM

Security<sup>1</sup>
• IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g

mode only

• AES-CCMP: 128 bit in hardware

• 802.1x authentication

WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

WPA2 certificationIEEE 802.11i

Cisco Certified Extensions, all versions through CCX4 and CCX

LiteWAPI

**Sub-channels** Multinational support with frequency bands and channels compliant to

local regulations.

**Network Architecture** 

Models

Ad-hoc (Peer to Peer)
Infrastructure (Access Point Required)

Roaming

Output Power<sup>2</sup>

IEEE 802.11 compliant roaming between band Access Points

2.4G: +13.5dBm minimum5G: +12dBm minimum

Power Consumption Transmit: 2.0 Watts

Receive: 1.6 Watts

Idle mode<sup>3</sup>: 250 mW (WLAN Associated) Idle mode: 100 mW (WLAN unassociated)

Radio off: 75 mW

Power Management ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity<sup>4</sup> 802.11g:-90 dBm (6 Mbps), -89 dBm (9 Mbps), -87 dBm (12 Mbps), -85

dBm (18 Mbps), -82 dBm (24 Mbps), -79 dBm (36 Mbps), -76 dBm (48

Mbps), -74 dBm (54 Mbps)

802.11b:-95 dBm (1 Mbps), -93 dBm (2 Mbps), -91 dBm (5.5 Mbps), -88

dBm (11 Mbps)

802.11g:-90 dBm (6 Mbps), -89 dBm (9 Mbps), -87 dBm (12 Mbps), -85



# **Technical Specifications**

dBm (18 Mbps), -82 dBm (24 Mbps), -79 dBm (36 Mbps), -76 dBm (48

Mbps), -74 dBm (54 Mbps)

802.11n:-69 dBm (150 Mbps), -66 dBm (300 Mbps)

**Antenna Connections** 2 U.FL type connectors (output impedance of  $50 \pm 2$  ohms)

Form Factor PCI-Express Half-MiniCard

**Dimensions** 0.12 x 1.06 x 1.18 in (3.1 x 26.8 x 30.0 mm)

Weight 3.1g

Operating Voltage 3.3v +/- 9%

**Temperature** Operating 14° to 158° F (-10° to 70° C)

Non-operating -40° to 176° F (-40° to 80° C)

**Humidity** Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

**Altitude** Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

**LED Activity** LED Amber - Radio OFF; Solid LED On - Radio ON

1. Check latest software/driver release for updates on supported security features.

2. Maximum output power may vary by country according to local regulations.3. In Power Save Polling mode and on battery power.

4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CCK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

5. WLAN supplier's client utility is required for Cisco Compatible Extensions support with Microsof Windows XP. WLAN may also be compatible with certain third-party software supplicants. WLAN supplier IHV extensions required for Cisco Compatible Extensions support for Microsoft Windows Vista.

\* Wireless access point and internet service required. Availability of public wireless access points limited.

Intel Dual Band Wireless-N 7260AN 802.11 a/b/g/n (2x2) WiFi + Bluetooth 4.0 Combo Adaptor\* Wireless LAN
Standards
IEEE 802.11a
IEEE 802.11b
IEEE 802.11g
IEEE 802.11n
Interoperability
Wi-Fi certified

Cisco Compatible Extensions Program compliant with Microsoft

Windows 7, Windows Vista and XP (details at: http://www.hp.com/go/notebooks/WLAN)

**Frequency Band** 802.11b/g/n 2.402 - 2.482 GHz

802.11a/n 4.9 - 4.95 GHz (Japan)

5.15 - 5.25 GHz 5.25 - 5.35 GHz 5.47 - 5.725 GHz 5.825 - 5.850 GHz

Antenna Structure 2 transmit; 2 receive (2x2)

**Data Rates** 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

802.11b: 1, 2, 5.5, 11 Mbps

802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

802.11n: card will support rates for NSS=1 and NSS=2 for RX and TX for 20 and 40 MHz channels. Short and long guard interval shall be

supported.

Modulation Direct Sequence Spread Spectrum

CCK, BPSK, QPSK, 16-QAM, 64-QAM

• IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g



# **Technical Specifications**

mode only

AES-CCMP: 128 bit in hardware

802.1x authentication

• WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

WPA2 certificationIEEE 802.11i

Cisco Certified Extensions, all versions through CCX4 and CCX

WAPI

Sub-channels Multinational support with frequency bands and channels compliant to

local regulations.

**Network Architecture** 

Ad-hoc (Peer to Peer)

**Models** 

Infrastructure (Access Point Required)

Roaming

IEEE 802.11 compliant roaming between band Access Points

Output Power<sup>2</sup>

2.4G: +13.5dBm minimum5G: +12dBm minimum

**Power Consumption** 

Transmit: 2.0 Watts

Receive: 1.6 Watts Idle mode<sup>3</sup>: 250 mW (WLAN Associated) Idle mode: 100 mW (WLAN unassociated)

Radio off: 75 mW

**Power Management** 

ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity<sup>4</sup>

802.11g:-90 dBm (6 Mbps), -89 dBm (9 Mbps), -87 dBm (12 Mbps), -85 dBm (18 Mbps), -82 dBm (24 Mbps), -79 dBm (36 Mbps), -76 dBm (48

Mbps), -74 dBm (54 Mbps)

802.11b:-95 dBm (1 Mbps), -93 dBm (2 Mbps), -91 dBm (5.5 Mbps), -88

dBm (11 Mbps)

802.11g:-90 dBm (6 Mbps), -89 dBm (9 Mbps), -87 dBm (12 Mbps), -85 dBm (18 Mbps), -82 dBm (24 Mbps), -79 dBm (36 Mbps), -76 dBm (48

Mbps), -74 dBm (54 Mbps)

802.11n:-69 dBm (150 Mbps), -66 dBm (300 Mbps)

**Antenna Connections** 2 U.FL type connectors (output impedance of 50  $\pm$  2 ohms)

Form Factor PCI-Express Half-MiniCard

**Dimensions** 0.12 x 1.06 x 1.18 in (3.1 x 26.8 x 30.0 mm)

Weight 3.1g

Operating Voltage 3.3v +/- 9%

**Temperature** Operating 14° to 158° F (-10° to 70° C)

Non-operating -40° to 176° F (-40° to 80° C)

**Humidity** Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

Altitude Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

**LED Activity** LED Off - Radio OFF; Solid LED On - Radio ON

1. Check latest software/driver release for updates on supported security features.

2. Maximum output power may vary by country according to local regulations.

3. In Power Save Polling mode and on battery power.

4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CCK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

5. WLAN supplier's client utility is required for Cisco Compatible Extensions support with Microsol Windows XP. WLAN may also be compatible with certain third-party software supplicants. WLAN



# **Technical Specifications**

supplier IHV extensions required for Cisco Compatible Extensions support for Microsoft Windows Vista.

HP Integrated Module with Bluetooth 4.0+EDR Wireless Technology

Bluetooth Specification 4.0+EDR Compliant

**Dimensions** 1.18 x 0.26 x 0.13 in (30 x 6.5 x 3.25 mm)

Frequency Band 2402 to 2480 MHz

**Number of Available** 

Channels

79 (1 MHz) available channels

**Data Rates and** 3 Mbps data rate; throughput up to 2.17 Mbps

Throughput Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric or 1306.9 kbps symmetric

**Transmit Power** -1.5 dBm to 4 dBm (Bluetooth Class II)

Receiver Sensitivity Better than -20 dBM at 0.1 % raw bit error rate

Power Consumption Peak (Tx) 264 mW

Peak (Rx) 231 mW Sleep <1 mW

Antenna Internally integrated within module

Range Up to 33 ft (10 m)

Electrical Interface USB 2.0 compliant

Microsoft Windows Plug and Play compliant

**Bluetooth Software** 

**Supported** 

Broadcom Bluetooth for Windows
Microsoft Windows Bluetooth Software

Link TopologyPoint to Point, Multipoint Pico Nets up to 7 slavesSecurityFull support of Bluetooth Security Provisions

Power Management Microsoft Windows ACPI, and USB Bus Support

Self configurable to optimize power conservation in all operating modes,

including Standby, Hold, Park, and Sniff

**Certifications** All necessary regulatory approvals for supported countries, including:

FCC (47 CFR) Part 15C, Section 15.247 & 15.249

ETS 300 328, ETS 300 826 Low Voltage Directive IEC950

UL, CSA, and CE Mark

Bluetooth Profiles Supported

Serial Port Profile (SPP)<sup>1</sup>

Service Discovery Application Profile (SDAP)

Dial-Up Networking (DUN)<sup>1,2</sup>

Generic Object Exchange Profile (GOEP)<sup>1,2</sup>

Object Push Profile (OPP)<sup>1,2</sup>
File Transfer Profile (FTP)
Synchronization Profile (SYNC)

Hard Copy Cable Replacement (HCRP)<sup>1,2</sup> Personal Area Networking Profile (PAN)<sup>1,2</sup> Human Interface Device Profile (HID)<sup>1,2</sup>

FAX Profile (FAX)

Basic Imaging Profile (BIP)<sup>2</sup>
Headset Profile (HSP)
Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)



# **Technical Specifications**

- 1. indicates the profile is supported by Microsoft Windows XP SP2
- 2. indicates the profile is part of Windows Vista
- \* Wireless access point and internet service required. Availability of public wireless access points limited.

Intel Dual Band Wireless-AC 7260 802.11 ac (2x2) WiFi + BT 4.0 combo Adapter\*

Wireless LAN IEEE 802.11a
Standards IEEE 802.11b
IEEE 802.11g
IEEE 802.11n
IEEE 802.11ac

Interoperability Wi-Fi certified Frequency Band 802.11b/g/n

2.402 - 2.482 GHz

#### 802.11a/n

- 4.9 4.95 GHz (Japan)
- 5.15 5.25 GHz
- 5.25 5.35 GHz\
- 5.47 5.725 GHz
- 5.825 5.850 GHz
- 2.402 2.482 GHz

#### **Data Rates**

- 802.11b: 1, 2, 5.5, 11 Mbps
- 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
- 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)
- 802.11ac : MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, and 80MHz)

### Modulation

Direct Sequence Spread Spectrum

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

### Security<sup>1</sup>

- IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only
- AES-CCMP: 128 bit in hardware
- 802.1x authentication
- WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.
- WPA2 certification
- IEEE 802.11i
- Cisco Certified Extensions, all versions through CCX4 and CCX Lite
- WAPI

## **Network Architecture**

**Models** 

**Network Architecture** 

Models

### Roaming

Output Power<sup>2</sup>

IEEE 802.11 compliant roaming between access points

- 2.4G: +13.5dBm minimum
- 5G: +12dBm minimum
- Maximum output power must be able to achieve modular regulatory certification with notebooks that have antennas >20cm from the user and peak gain of +3dBi at 2.4GHz and +4dBi at 5GHz

#### **Power Consumption**

Transmit: 2.0 W (max) Receive: 1.6 W (max)

Idle mode (PSP): 250 mW (WLAN Associated) Idle mode: 100 mW (WLAN unassociated)

Radio disabled: 75 mW



# **Technical Specifications**

Power Management ACPI and PCI Express compliant power management

802.11 compliant power saving mode

**Receiver Sensitivity**<sup>3</sup> 802.11b:-95 dBm (1 Mbps), -93 dBm (2 Mbps), -91 dBm (5.5 Mbps), -88

dBm (11 Mbps)

802.11a/g:-90 dBm (6 Mbps), -89 dBm (9 Mbps), -87 dBm (12 Mbps), -85 dBm (18 Mbps), -82 dBm (24 Mbps), -79 dBm (36 Mbps), -76 dBm

(48 Mbps), -74 dBm (54 Mbps)

802.11n:-69 dBm (72.2 Mbps), -66 dBm (300 Mbps)

**Antenna Connections** High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card

to support WLAN MIMO communications and Bluetooth

communications

Form Factor PCI-Express Half-MiniCard

**Dimensions** 0.19 x 1.06 x 1.18 in (4.75 x 26.8 x 30 mm)

Weight 3.1g

Operating Voltage 3.3v +/- 9%

**Temperature** Operating 14° to 158° F (-10° to 70° C)

Non-operating -40° to 176° F (-40° to 80° C)

**Humidity** Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

**Altitude** Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

**LED Activity** LED Off - Radio OFF; Solid LED On - Radio ON

1. Check latest software/driver release for updates on supported security features.

2. Maximum output power may vary by country according to local regulations.

Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

### **Bluetooth Specification**

V4.0 High Speed, V2.1+EDR, backwards compatible with V1.1, 1.2 and 2.0

**Number of Available** 

Channels

79 (1 MHz) available channels

**Data Rates and** 

**Throughput** 

3 Mbps data rate; throughput up to 2.17 Mbps

Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric or 1306.9 kbps symmetric

**Transmit Power** -6 dBm to 4 dBm (Bluetooth Class II)

**Receiver Sensitivity** Better than -80 dBM at 0.1 % raw bit error rate

Power Consumption Peak (Tx) 330 mW

Peak (Rx) 230 mW Sleep <17 mW

Antenna Internally integrated within module

Range Up to 33 ft (10 m)

Electrical Interface USB 2.0 compliant

Microsoft Windows Plug and Play compliant

**Bluetooth Software** 

Supported

Broadcom Bluetooth for Windows Microsoft Windows Bluetooth Software



**Link Topology** Point to Point, Multipoint Pico Nets up to 7 slaves Security Full support of Bluetooth Security Provisions

**Power Management** Microsoft Windows ACPI, and USB Bus Support

Self-configurable to optimize power conservation in all operating modes,

including Standby, Hold, Park, and Sniff

Certifications All necessary regulatory approvals for supported countries, including:

FCC (47 CFR) Part 15C, Section 15.247 & 15.249

ETS 300 328, ETS 300 826 Low Voltage Directive IEC950 UL, CSA, and CE Mark

**Bluetooth Profiles** 

**Supported** 

Generic Access Profile (GAP)

Service Discovery Application Profile (SDAP)

Serial Port Profile (SPP)

Dial Up Networking Profile (DUN)

Generic Object Exchange Profile (GOEP)

Object Push Profile (OPP) File Transfer Profile (FTP) Synchronization Profile (SYNC) Hard Copy Cable Replacement (HCRP)

Personal Area Networking Profile (PAN) Human Interface Device Profile (HID)

Generic Audio/Video Distribution Profile (GAVDP) Advanced Audio/Video Distribution Profile (A2DP)

FAX Profile (FAX)

Basic Imaging Profile (BIP) Headset Profile (HSP) Hands Free Profile (HFP) Basic Printing Profile (BPP) VDP (Video Distribution Profile)

AVRCP (Audio Video Remote Control Profile)

### AUDIO/MULTIMEDIA - DTS SOUND+

**Hardware IDT 92HD91** Implementation

**Controls** 

Function Key Volume Volume up, volume down, and mute

**Full Duplex** Yes Microphone In Stereo Headphone/Line Out Stereo

Integrated Microphone Yes, dual digital microphone array when equipped with optional webcam



<sup>\*</sup> Wireless access point and internet service required. Availability of public wireless access points limited. The specifications for the 802.11ac WLAN are draft specifications and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ac WLAN devices

# Technical Specifications

**Audio Output Quality Frequency Response** 20 Hz - 20 kHz

> Signal to Noise Ratio >85 dB **Total Harmonic** 0.01%

**Distortion** 

**Noise Floor** -110 dB

Play/Record Sampling 8 kHz - 48kHz

Rate(s)

DAC 16, 20 or 24-bit **ADC** 16 or 20-bit

**Integrated Stereo** 

**Power Rating Speakers Impedance** 

2 Watts 4 Ohms

## **POWER**

**HP 45W Slim Smart AC Dimensions** 3.78 x 1.95 x 0.88 in (9.6 x 4.95 x 2.24 cm)

**Adapter** Input

90 to 265 VAC 87% min at 115 VAC Input Efficiency

Input frequency range 47 to 63 Hz

1.4 A at 90 VAC and maximum load Input AC current

45W **Output Output power** 

DC output 19.5V

Hold-up time 5 msec at 115 VAC input

**Output current limit** <8A, Over voltage protection- 29V max

automatic shutdown

Connector 3 pin/grounded, mates with interchangeable cords 32° to 95° F (0° to 35° C) **Environmental Design Operating** 

temperature

Non-operating -4° to 121° F (-20° to 85° C)

(storage) temperature

**Altitude** 0 to 16,405 ft (0 to 5,000 m)

Humidity 0% to 95% 0% to 95% Storage Humidity

**EMI and Safety** Certifications

CE Mark - full compliance with LVD and EMC directives; Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE; Reliability failure rate of less than 0.1% annually within the first three years of

operation.



## **Technical Specifications**

**HP 45W Slim Smart AC Dimensions** (H x W x D) 95.0 x 40.0 x 26.5mm

Adapter non-slim Input 90 to 265 VAC

Input Efficiency 88% min at 115 VAC / 89% min at 230VAC

Input frequency range 47 to 63 Hz

Input AC current 1.4 A at 90 VAC and maximum load

Output Output power 45W

DC output 19.5V

**Hold-up time** 5 msec at 115 VAC input

Output current limit <8A, Over voltage protection- 29V max

automatic shutdown

**Connector** 3 pin/grounded, mates with 4.5mm barrel type Smart ID DC connector

**Environmental Design Operating** 32° to 95° F (0° to 35° C)

temperature

**Non-operating** -4° to 121° F (-20° to 85° C)

(storage) temperature

**Altitude** 0 to 16,405 ft (0 to 5,000 m)

**Humidity** 0% to 95% **Storage Humidity** 0% to 95%

**EMI and Safety Certifications** 

CE Mark - full compliance with LVD and EMC directives; Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE; Reliability - failure rate of less than 0.1% annually within the first three years of

operation.

HP 45W Slim Smart AC Dimensions (H  $\times$  W  $\times$  D) 95.0  $\times$  40.0  $\times$  26.5mm

Adapter non-slim 2

prong

Input 90 to 265 VAC

Input Efficiency 88% min at 115 VAC / 89% min at 230VAC

Input frequency range 47 to 63 Hz

Input AC current 1.4 A at 90 VAC and maximum load

Output Output power 45W

DC output 19.5V

**Hold-up time** 5 msec at 115 VAC input

Output current limit <8A, Over voltage protection- 29V max

automatic shutdown

**Connector** 2 pin/non-grounded, mates with 4.5mm barrel type Smart ID DC

connector

**Environmental Design Operating** 32° to 95° F (0° to 35° C)

temperature

**Non-operating** -4° to 121° F (-20° to 85° C)

(storage) temperature

**Altitude** 0 to 16,405 ft (0 to 5,000 m)

**Humidity** 0% to 95% **Storage Humidity** 0% to 95%



**EMI and Safety** Certifications

CE Mark - full compliance with LVD and EMC directives; Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV: Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE; Reliability failure rate of less than 0.1% annually within the first three years of operation.

# HP 65W EM Smart AC

**Adapter** 

**Dimensions** 126.0 x 50.0 x 30.0 mm

Weight 300 g

Input 90 to 265 VAC

> Input Efficiency 87% min at 115 VAC

Input frequency range 47 to 63 Hz

**Input AC current** 1.7 A at 90 VAC

**Output** 65W **Output power** DC output 19.5V

> Hold-up time 5 msec at 115 VAC input

Output current limit <11A, Over voltage protection- 29V max

automatic shutdown

Connector **Environmental Design** 

3 pin/grounded, mates with interchangeable cords 32° to 95° F (0° to 35° C) Operating

temperature

Non-operating -4° to 185° F (-20° to 85° C)

(storage) temperature

**Altitude** 0 to 10,000 ft (0 to 3,048 m)

**Humidity** 20% to 95% 10% to 95% Storage Humidity

**EMI and Safety** Certifications

CE Mark - full compliance with LVD and EMC directives: Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE; MTBF - over

200,000 hours at 25°C ambient condition.

### **HP 65W Smart Travel AC Adapter**

**Dimensions** 

120.0 x 57.6 x 16.7 mm

Weight 250 g

Input 90 to 265 VAC

> **Input Efficiency** 88% min at 115 VAC / 89% min at 230VAC

Input frequency range 47 to 63 Hz Input AC current 1.7 A at 90 VAC

65W **Output Output power** 

> 18.5V DC output

Hold-up time 5 msec at 115 VAC input

<11A, Over voltage protection- 29V max Output current limit

automatic shutdown

Connector 3 pin/grounded, mates with interchangeable cords **Environmental Design Operating** 32° to 104° F (0° to 40° C)

temperature

-4° to 149° F (-20° to 65° C) Non-operating

(storage) temperature



**Altitude** 0 to 10,000 ft (0 to 3,048 m)

Humidity 20% to 80% Storage Humidity 10% to 90%

**EMI and Safety Certifications** 

CE Mark - full compliance with LVD and EMC directives; Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE; MTBF - over

200,000 hours at 25°C ambient condition.

HP 6-cell (42 WHr) Polymer Primary battery **Dimensions** (L x W x H) 13.3 x 4.94 x 0.31 in (33.79 x 12.545 x 0.785 cm)

Weight (max) 0.225kg
Cells/Type 6-cell Polymer

Energy Voltage 11.1V
Amp-hour capacity 3.86Ah
Watt-hour capacity 42Wh

**Temperature**Operating (Charging) 32° to 113° F (0° to 45° C)
Operating 14° to 140° F(-10° to 60° C)

(Discharging)

**Non-operating**  $-4^{\circ}$  to  $140^{\circ}$  F ( $-20^{\circ}$  to  $60^{\circ}$  C)

Battery Re-Charge

Time

System in OFF or Standby Mode

System ON This depends on system setting

This depends on system setting

**Fuel Gauge LED** No **Optional Travel Battery** No

Available

### **ENVIRONMENTAL**

#### **Environmental Data**

Eco-Label Certifications

This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- IT ECO declaration
- US ENERGY STAR®
- EPEAT Gold registered in the United States. See http://www.epeat.net for registration status in your country.

**System Configuration** 

The configuration used for the Energy Consumption and Declared Noise Emissions data for the Commercial Notebook model is based on a "Typically Configured Notebook"

Energy Consumption	115 VAC	230 VAC	100 VAC
Normal Operation	3.40 W	3.26 W	3.32 W
Sleep	0.92 W	0.94 W	0.93 W
Off	0.38 W	0.45 W	0.38 W

#### NOTE:

Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family. HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR®



# **Technical Specifications**

specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

Heat Dissipation*	115 VAC	230 VAC	100 VAC
Normal Operation	12 BTU/hr	11 BTU/hr	11 BTU/hr
Sleep	3 BTU/hr	3 BTU/hr	3 BTU/hr
Off	1 BTU/hr	2 BTU/hr	1 BTU/hr

<sup>\*</sup> Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)

System Fan Off	Sound Power	Sound Pressure
	(LWAd, bels)	(LpAm, decibels)
Typically Configured - Idle	2.8	25
Fixed Disk -	2.8	25
Random writes		

**Batteries** 

This battery(s) in this product comply with EU Directive 2006/66/EC

Batteries used in the product do not contain:

Mercury greater the 5ppm by weight

Cadmium greater than 10ppm by weight

Battery size: CR2025 (coin cell)

Battery type: Lithium

# Additional information

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive 2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold level, see <a href="https://www.epeat.net">www.epeat.net</a>
- Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.
- This product contains 2.6 % post-consumer recycled plastic (by wt.)
- This product is 97.2 % recycle-able when properly disposed of at end of life.

#### **Packaging Materials**

- External:
  - PAPER/Cardboard & misc 295 g
  - PAPER/Corrugated 14 g
- Internal:
  - O PLASTIC/Polyethylene low density 65 g
  - O PLASTIC/EPE-Expanded Polyethylene- 2 g
  - o PLASTIC/PET 1 g
  - O OTHER/OTHER 24 g
- The PAPER/Cardboard & misc packaging material is made from 80 % recycled content.



- The PAPER/Corrugated packaging material is made from 80 % recycled content.
- The PLASTIC/Polyethylene low density packaging materials contains at least 65% recycled content.
- The PLASTIC/EPE-Expanded Polyethylene packaging materials contains at least 65% recycled content.
- The PLASTIC/PET packaging materials contains at least 65% recycled content.
- The OTHER/OTHER materials contains at least 65% recycled content

#### **Material Usage**

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at: http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Formaldehvde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries
- Nickel finishes must not be used on the external surface designed to be frequently handled or carried by the user.
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

### **Packaging Usage**

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

**End-of-life** 

Hewlett-Packard offers end-of-life HP product return and recycling



# Management and Recycling

programs in many geographic areas. To recycle your product, please go to: <a href="http://www.hp.com/go/reuse-recycle">http://www.hp.com/go/reuse-recycle</a> or contact your nearest HP sale office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: <a href="http://www.hp.com/go/recyclers">http://www.hp.com/go/recyclers</a>. These instructions may be used by recyclers and other WEEE treatmen facilities as well as HP OEM customers who integrate and re-sell HP equipment.

Hewlett-Packard Corporate Environmental Information For more information about HP's commitment to the environment:

Global Citizenship Report

http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html

Eco-label certifications

http://www8.hp.com/us/en/hp-information/environment/ecolabels.html

ISO 14001 certificates:

http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/PC\_

GBU\_Product\_Design\_ISO\_14K\_Certificate.pdf

and

http://www.hp.com/hpinfo/globalcitizenship/environment/

pdf/cert.pdf

### **COUNTRY OF ORIGIN**

China



Options and Accessories (sold separately and availability may vary by country)

Туре	Description	Part #
Cases	HP Slim Ultrabook Messenger	F3W14AA
	HP Slim Ultrabook Top Load Case (15.6")	F3W15AA
	HP Slim Ultrabook Backpack	F3W16AA
	HP 4 Wheel Roller	H5M93AA
Docking	HP Display and Notebook II Stand	E8G00AA
	HP Dual Hinge Notebook II Stand	E8F99AA
	HP Adjustable Dual Display Stand	AW664AA
	HP UltraSlim Side Docking Station	D9Y32AA
	HP 2005pr USB 2.0 Port Replicator	H1L07AA#xxx
	HP 3005pr USB 3.0 Port Replicator	H1L08AA#xxx
Input/Output - Mice	HP Slim Bluetooth Mouse	F3J9AA
	HP Wireless Mobile Mouse	H2L63AA
	HP Touch To Pair Mouse	H6E52AA
	HP Stylish USB Keyboard and Mouse	H4B80AA
Adapters	HP Smart 65W Travel AC Adapter	AU155AA#xxx
	HP 65W Slim Adapter	AX727AA#xxx
	HP 90W Smart AC/Auto/Air Combo Adapter	AJ652AA#xxx
	HP EliteFolio RJ45/VGA Adapter	F3W44AA
	HP DisplayPort to HDMI Adapter	BP937AA
Storage - External Storage	HP External USB DVD/RW Drive	F2B56AA
Health and Education	HP 20-Notebook Managed Charging Cart	QL489AA
	HP 20-Notebook Charging Cart	QL488AA
	HP 30-Notebook Managed Charging Cart	QL490AA
Security	HP UltraSlim Keyed Cable Lock	H4D73AA
Monitors	HP EliteDisplay E231 23-inch LED Monitor	C9V75AA/A8/AS/AT
	HP LA1956x 19-inch LED Monitor	A9S75AA/A8/AS/AT
	HP LA2405x 24-inch LED Monitor	A9P21AA/A8/AT
	HP ProDisplay P221 21.5" LED Monitor	C9E49AA/A8/AS/AT
	HP ProDisplay P201 20" LED Monitor	C9F26AA/A8/AS/AT



Options and Accessories (sold separately and availability may vary by country)

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